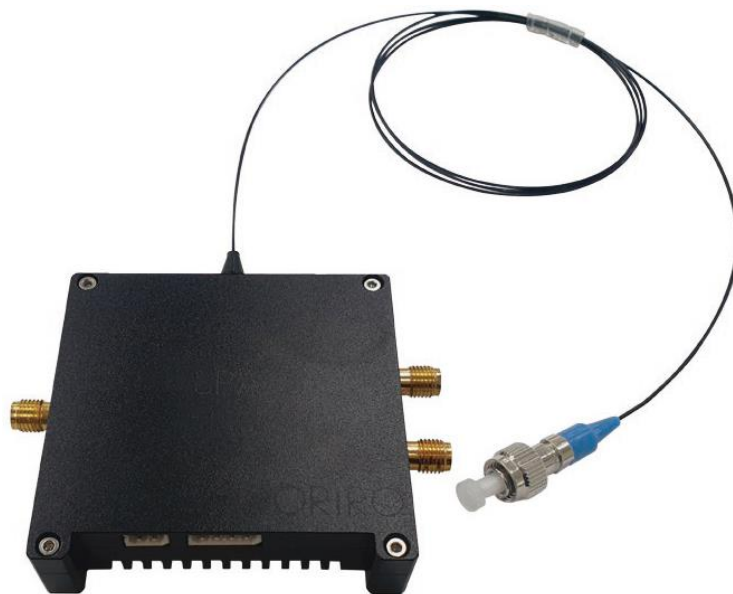


NFAD with TEC

(Pigtailed 10 pin Mini-Flat type Negative Feedback Avalanche Diode)



(NFAD with TEC Mini-Flat Type)



(NFAD with TEC Mini-Flat Type installed on Evaluation Board in Heatsink-integrated Case)

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General Description

InGaAs NFAD (Negative Feedback Avalanche Diode) is used for photon counting such as ultra-long distance Light Detection and Ranging (LiDAR) and Laser Range Finder (LRF), Free Space Quantum Communication, anything requires minute photon counting application, such as Gas sensors and Bio sensors, etc. It is based on the theory of low noise and high speed photo detection system using optical feedback with a current amplification function.

Features

- Built-in Quenching Resistor (Available Option : 360 kΩ/ 510 kΩ/ 680 kΩ/ 820 kΩ/ 1MΩ)
- Optimized for 1000 nm to 1600 nm wavelength
- SMF-28 single-mode Pigtail
- 10-pin Butterfly type Mini-Flat package
- Built in 3-stage cooling system
- Evaluation Board & Heat Sink **(Optional)**

Applications

- Quantum Cryptography (QKD)
- Light Detection and Ranging (LiDAR)
- Free Space Optical Communication
- Fundamental Studies in Quantum Physics

Absolute Maximum Ratings

Parameter	Conditions	Rating(Max.)	Unit
Forward Current	Continuous bias	1	mA
Forward Voltage	Continuous bias	1	V
Reverse Current	Continuous bias	1	mA
Reverse Voltage	DC Bias (free-running mode)	$V_{BR} + 5$	V
Optical Input Power	Continuous wave	1	mW
TEC Current	@27°C, Vacuum	2.6	A
TEC Voltage	@27°C, Vacuum	2.0	V
Thermistor	@25°C	10	kΩ
Storage Temperature	-	-40 to +85	°C

Table 1. Absolute Maximum Ratings

Electro-Optical Characteristics

Inspection sheet shall be appended to products when they are delivered. Test report shall be submitted in papers and in electronic media. It shall contain the major in following items.

Optical Characteristics (Tc=25°C)

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Breakdown Voltage	V_{BR}	$I_D=0.1\mu A$	60	70	80	V
Total dark current	I_D	$V_R = 0.95V_{BR}$		1		nA
Capacitance	C_{PD}	f = 1MHz, $V_{PD} = 0.9V_B$		0.1		pF
Quantum efficiency	η	M=1, 1550nm		70		%
Optical Wavelength Range	λ	-	1000		1600	nm
Responsivity	R	$\lambda = 1550\text{nm}$, M=1	0.7	0.8		A/W
Temperature coefficient of V_{BR}	Γ	$\Delta V_{BR}/\Delta T$		0.11		V/°C

Table 2. Optical Characteristics

Optical Characteristics (Tc= -40°C)

Parameter	Symbol	Test Condition	Min	Typ.	Max	Unit
Photon Detection efficiency	PDE	$T_C=-40^\circ C$	10			%
Dark count rate	DCR	@10% PDE $T_C=-40^\circ C$			10	KHz
Operating Excess voltage	ΔV			+2		V

Table 3. Optical Characteristics at GM operation

Mechanical Dimension & Pin Layout

(Unit : mm)

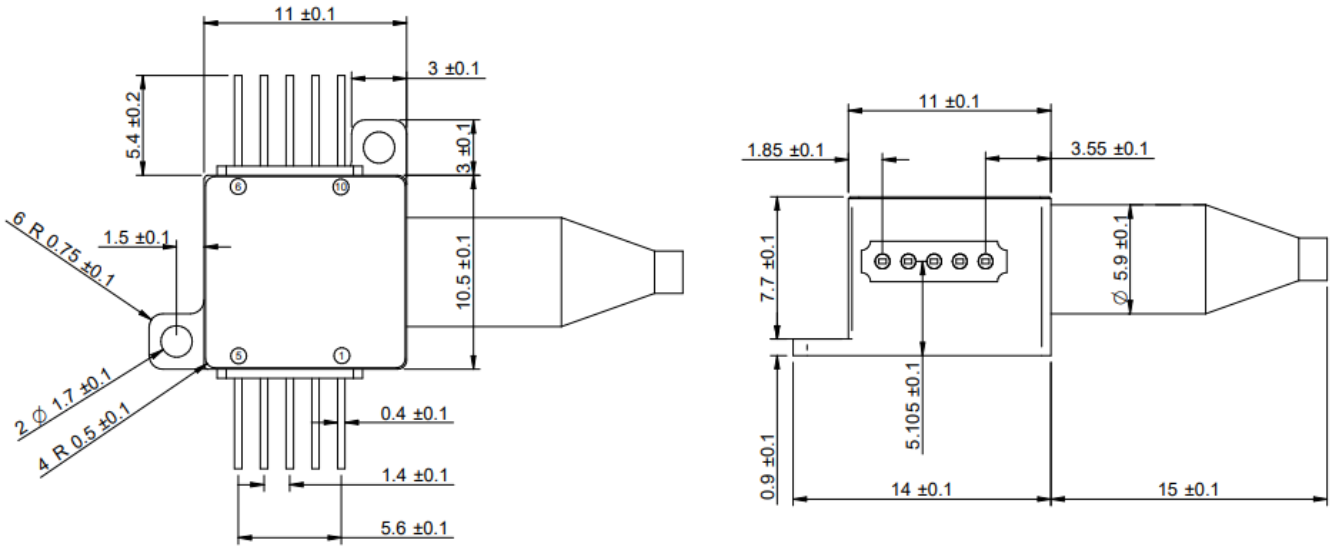


Figure 1. Mechanical Dimension

* Fiber length : 1m (Standard) , Connector : FC-PC (Standard)

No.	Symbol	I/O	Description (Top View)
1	A	-	APD Anode
2	N/C	-	N/C
3	GND	-	Case Ground
4	TH	-	Thermistor1
5	TEC	-	TEC(+)
6	TEC	-	TEC(-)
7	TH	-	Thermistor2
8	GND	-	Case Ground
9	N/C	-	N/C
10	C	-	APD Cathode

Table 4. PIN Configuration

Other Requirements

Precautions for use

This device is susceptible to damage as a result of ESD(electrostatic discharge). Use of ground straps, anti-static mats, and other standard ESD protective equipment is recommended when handling or testing an InGaAs PIN/APD or any other junction photodiode. Soldering temperature of the leads should not exceed 350°C for more than 3 seconds.

Ordering Information

WPGSTGMLISFPNO (NFAD with TEC Mini-Flat Type)

WPGSTGMLISFPEO (NFAD with TEC Mini-Flat Type installed on Evaluation Board in Heatsink-integrated Case)